PRELIMINARY DATA SHEET

53248-102

28 VDC SOLID STATE POWER CONTROLLER



Features:	Applications:
 Isolated Control Isolated Status Output Latched Fault Protection Thermal Shutdown Undervoltage & Overvoltage Shutdown Current Limit Short Circuit Protection 	 Power Distribution In Land/Air/Launch Vehicles Motor Switch Displays/Lamps/Controls Industrial Automation Switching Heaters Test Equipment Machine Control Equipment Medical Lab Equipment

DESCRIPTION

The **53248-102** is a 28 VDC Solid State High Side Power Controller (SSPC) that is designed to replace electromagnetic circuit breakers rated at up to 10 amperes. It is a high side switch utilizing N-channel vertical power FET technology with integral charge pump. The SSPC provides a status output that signals a variety of conditions including over temperature shutdown, overvoltage or undervoltage, over-current or short circuit. It will trip off and latch for any of the above conditions until reset by recycling of the control input.

Using vertical MOSFET technology, the SSPC offers extremely low "ON" resistance. This results in very low power dissipation, which allows operation over the temperature range of –40°C to +85°C with minimal heat sinking.

ABSOLUTE MAXIMUM RATINGS

(@ $T_c = 25^{\circ}C$ unless otherwise specified)

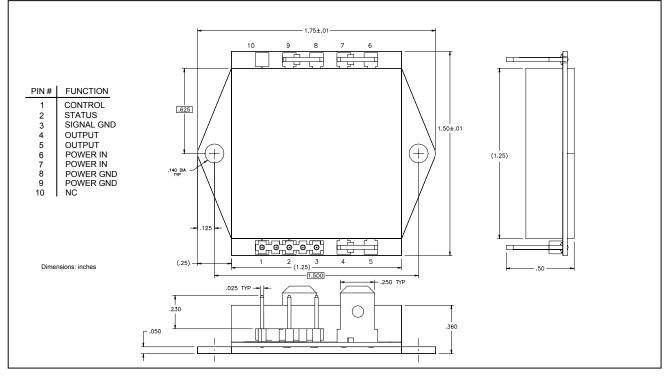
Input Control Current	10 mA
Reverse Input Voltage (Control to Signal Ground)	5 VDC
Pins to Case Isolation	1000 VDC
Input-Output Isolation	1000 VDC
Lead Temperature (15 seconds)	+300°C
Junction Temperature	
Blocking Voltage	

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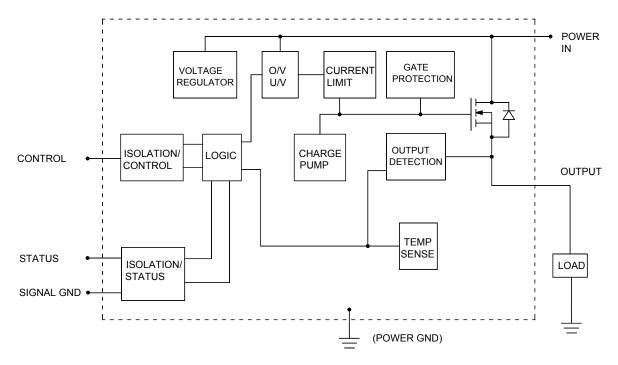
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Package Configuration



Functional Block Diagram



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SPECIFICATIONS

(@ T_C 25°C unless otherwise specified)

Control Function

Input Type	
Turn on Control Current	
Turn-off Control Current	

Status Function

Open Collector transistor, $V_{CC} = +40$ VDC (max) Output High is V_{CC} , Output Low is +0.4 V (max) @ $I_{CC} = 10$ mA (max) Status output transistor off (logic high) indicates unit is off. Status output transistor on (V ≤ 0.4 VDC) indicates unit is on.

Power Circuit

Supply Voltage (for normal operation)	5 VDC (min), 28 VDC (typ), 40 VDC (max)
Continuous Current	
On-state Resistance, $T_i @ 25^{\circ}C (I_L \ge 5A)$	
On-state Resistance, $T_i \otimes 150^{\circ}C (I_L \ge 5A)$	
Minimum Output Voltage Drop (IL = 0.5A)	
Power Dissipation at $T_c = 25^{\circ}C$ and Full Load	4 W
Power Output Leakage Through Load (off state, V supply = 28VDC)	15 μΑ
Quiescent Current (@ No load) (V supply = 28VDC)	

Temperature Range

Operating (Case)	40°C to +85°C
Storage	55°C to +150°C

Thermal Resistance

ction to Case

Physical Characteristics

See Package Configuration

Timing at 28 VDC (I_L =1A)

Turn-on Time	300 µsec (max)
Status Turn-on Delay	400 µsec (max)
Turn-off Time	
Status Turn-off Delay	• • • •

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FUNCTIONAL DESCRIPTION

The **53248-102** SSPC offers a wide range of features. These include overvoltage and undervoltage shutdown, overcurrent and short circuit protection provided by temperature sensing, built in transient protection and fully optically isolated control and status lines. The overcurrent and short circuit protection are achieved through the temperature sensing feature of the controller. Overcurrent is sensed through the increasing $R_{DS(ON)}$ causing increase power dissipation in the pass element, which additionally causes a further increase in $R_{DS(ON)}$. As junction temperature approaches +150°C, drive to the pass element is decreased, causing V_{DS} to increase. When the pass element temperature is between +150°C and +175°C, the drive to the pass element is removed and current flow ceases. When the control is recycled and if the fault condition has been removed the device will resume operations. Status will indicate a fault condition until the fault is removed.

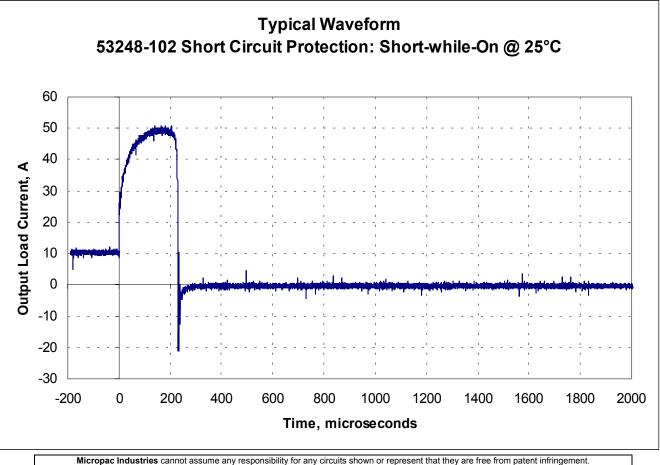
Peak Current Limits vs. Junction Temperature*

Junction Temperature	Min	Тур	Max	Unit
-40°C			74	Α
+25°C		44		Α
+150°C	24			Α

Overvoltage and Undervoltage Limits

Overvoltage	+42 VDC to +52 VDC
Undervoltage	+2.4 VDC to +4.5 VDC
Overvoltage hysteresis	Typical +0.2 VDC
Undervoltage hysteresis	Typical +0.2 VDC
$(T_i = -40^{\circ}C \text{ to } +150^{\circ}C)$	

*Peak Duration



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APPLICATION INFORMATION

The cable harness occupies an important position in the total network to be protected. The wide variety and in some cases considerable length and packing density used makes them particularly susceptible to persistent overloads and/or overheating. The maximum current carrying capacity of a cable depends on its resistance, type of insulation material and the ambient temperature. A cable, including insulation, generally consists of at least two materials with different thermal capacitance and thermal resistance. The maximum temperatures of most cables are at least +150°C (depending on the insulation properties) which is very close to the maximum junction temperature of the SSPC (Shutdown). Since under overcurrent or short circuit conditions, the unit resistance per unit length for the cable is much less than the R_{DS} of the SSPC, the unit heating of the cable will also be much less. Under these conditions, it is apparent that the SSPC can adequately protect properly selected cabling.

The following formulas provide methods for calculating the primary parameters.

Trip Current

$$I_{trip} = \{(T_{j \text{ max}} - T_{a})/[R_{\theta ja}][R_{ON (Tj \text{ max})}]\}^{1/2}$$

T _{j max} =	Maximum	Trip	Temperature
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T_a = Ambient Temperature

$R_{\theta ja}$ = Thermal Resistance, Junction to Ambient R_{on (Tj max)} = On-state resistance at Trip Temperature

On-state Resistance

 $R_{on} (T) = R_{25} x e^{0.006 (T - 25)}$ $R_{25} = on-state resistance at 25°C$ e = 2.718282 (natural logarithm) $T = T_i at temperature of interest in °C$

With the above information, the temperature and current trip can be determined based upon the type of mounting chosen and the ambient temperatures of operation.

Precaution

When a short circuit causes turn-off of the SSPC, precautions must be taken to limit transient voltages generated by any inductance in the load to less than the max voltage blocking of the SSPC (i.e. 63V). External protection is recommended, either across the switch or across the load, to limit voltage transients to levels less than 63V to insure the SSPC maximum blocking voltage is not exceeded.

Isolation of Control and Status

The SSPC was designed to utilize optical isolation both on the input/control and the status feed back. The only input power required is that necessary to drive a control LED and provide pull up power for the open collector status transistor. The SSPC derives its energy for operation from the 28 VDC load supply. As a result, the power in and power out are completely isolated.

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Truth Table

	Control	Output	Status
Normal Operation	L	L H	H L
Current Overload	L H	L	H H
Over-Temperature	L H	L	H H
Undervoltage	L H	L	H H
Overvoltage	L	L L	H

Note:

For Control Output: L = "Low" Level Voltage

H = "High" Level Voltage

For Status H = Open Collector

L = Current Sink

Loads

The 53248-102 SSPC is designed to handle low side loads from +5 VDC to +40 VDC. Combinations of inductive, resistive and capacitive may be used. This includes lamps and DC motors.

Inductive loads require protecting the SSPC from voltage transients as pointed out in the precaution section above. For capacitive loads, the user must assure that junction temperature of the body is not exceeded. If at turn off, the V_{CC} drops below the voltage charge on the capacitor, current can flow through the body diode of the FET switch with no inherent capability to limit this spike of reverse current. Incandescent lamps must be treated much like capacitive loads in that in-rush currents at turn-on can cause an overcurrent condition.

DC motors must be treated like capacitive loads because in-rush currents can be very high. Should a machine continue to rotate after power is removed, reverse currents due to back EMF need to be addressed.

Heatsinking

The SSPC is designed to take advantage of the relationship between junction temperatures and heat sink thermal impedance. As described in the section discussing current trip characteristics, the thermal impedance of the heat sink utilized can determine the magnitude and time of over current or short circuit current expected in a system.

Offset voltage

The Power MOSFETs used in Micropac's SSPC have very low on resistance and therefore low power dissipation. Typical on-state resistance at 25°C is only 38 m Ω . Due to internal design the typical V_{DS} at 0.5 A is 50 mV. This stays relatively constant until the current reaches approximately 2 amperes when V_{DS} is 60 mV. For higher currents, the R_{DS} is constant at T_i of +25°C. Maximum R_{DS} at +150°C is 80 mΩ.

Since the design of SSPC current limit is temperature dependent, there is no need for a current sensing resistor and therefore no additional voltage drop which would add to the R_{DS}.

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